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High open-circuit voltage of graphene-based photovoltaic cells modulated by layer-by-layer transfer

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Graphene has shown great application opportunities in future nanoelectronic devices because of its outstanding electronic properties. Moreover, its impressive optical properties have been attracting the interest of researchers, and, recently, the photovoltaic effects of a heterojunction structure embedded with few layer graphene (FLG) have been demonstrated. Here, we report the photovoltaic response of graphene–semiconductor junctions and the controlled open-circuit voltage (V_{oc}) with varying numbers of graphene layers. After unavoidably adsorbed contaminants were removed from the FLGs by means of *in situ* annealing, prepared by layer-by-layer transfer of the chemically grown graphene layer, the work functions of FLGs showed a sequential increase as the graphene layers increase, despite random interlayer-stacking, resulting in the modulation of photovoltaic behaviors of FLGs/Si interfaces. The surface photovoltaic effects observed here show an electronic realignment in the depth direction in the FLG heterojunction systems, indicating future potential toward solar devices utilizing the excellent transparency and flexibility of FLG. Copyright © 2011 John Wiley & Sons, Ltd.

Keywords: Photovoltaic; Graphene; Photoelectron spectroscopy

Introduction

Graphene has shown remarkable photonic properties, such as high transparency and wide absorption spectral range, and outstanding electronic and mechanical properties, so extensive interest has developed toward applying it to optoelectronic devices. [1-8] The success in growing a qualified wide-area few layer graphene (FLG), comparable to one exfoliated from graphite, using chemical vapor deposition method (CVD) enables researchers to readily apply it to optoelectronic devices and quantitatively analyze its driving mechanism. [9] The graphene heterojunction system is the most commonly encountered structure in the study of graphene itself and in building application-oriented interfaces. In these systems, graphene-substrate interactions induce significant effects on the observed results because of the atomic-order thinness of the graphene; the graphene surface is never free from the influence of interface effects. One of these effects is the surface photovoltage, which can be found in the low coverage metal/semiconductor junction. [10] A similar effect was reported in the field effect transistor consisting of graphene on an insulating surface with metal pattern, which showed a photo response driven by lateral band transition when the graphene crosses the different substrate surfaces, i.e. the edge effect. [5,6,11,12] It is known that the optical properties of FLG directly depend on the number of layers because of different transparencies and absorbance processes.^[5,6] However, it is not well studied why and how photo-responses depend on the modulated electronic structures of FLG with different numbers of layers when it is applied to a heterojunction system. Recently, it had been reported that the work function of double layer graphene exfoliated from graphite differs from that of single layer graphene because of chemical stabilization induced by an interlayer interaction.^[13] Here, we show that the work function of the FLG prepared by layer-by-layer transfer of the CVD-grown graphene increases as the number of layers increases, and this is directly connected to open-circuit voltage modulation of an FLG/Si photovoltaic cell.

Experiment

The large-area graphene layers were synthesized by CVD of methane gas on Cu foils at $1000\,^{\circ}\text{C.}^{[14]}$ After the graphene film was spin-coated at 3000 rpm with 5 wt% polymethylmethacrylate (PMMA) in chlorobenzene, the underlying Cu foil was etched by 0.5 M aqueous FeCl₃ solution. Subsequently, the PMMA-supported graphene layer was transferred onto Si substrates and dried on a hot plate at 80 °C. Finally, acetone was used to remove the PMMA layer. The substrate Silicon(N_a (Boron) = 2× 10^{15} cm⁻³) with native oxide on its surface was cleaned by sonication in the acetone solution for 30 min. Annealing for *in situ*

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cleaning and spectroscopic measurement of the samples were carried out at the 4B1 PES II Beamline at the Pohang Light Source in the Pohang Accelerator Laboratory in Korea. The devices were mounted onto a grounded molybdenum holder, thermally linked by phosphor–boron nitride composites to a resistance heater. The top-lying FLGs in the devices were characterized via photoemission electron spectroscopy at several annealing steps in the analysis chamber (base pressure 4×10^{-10} torr).

The Raman spectra showed that the transferred graphene film consists of >95% monolayers.^[14] As the graphene layers were transferred one after another,^[16] the intensities of G and 2D band peaks increased together, but their ratios did not change significantly (Fig. 1). This is because the hexagonal lattices of the upper and lower layers are randomly oriented, unlike graphite, so that the original properties of each monolayer remain unchanged even after stacking into multilayers.^[17,18] This is clearly different from the case of multilayer graphene exfoliated from graphite crystals.^[19] The Raman spectra of the graphene layers transferred onto Si do not show D peaks near 1300 cm⁻¹, indicating the high quality of the graphene films. The transmission electron microscopy (TEM) image also shows that the graphene film is a high-quality monolayer without many defects (Fig. 1 inset. For more images, see Figure S4 in ^[14]).

Results and discussions

A schematic view of a prototype of the photovoltaic device is shown in Fig. 2(a). A graphene sheet (1 ML, $10 \times 10 \,\mathrm{mm^2}$) was repeatedly transferred onto a p-type Si (Density of N_a (Boron) = $2 \times 10^{15} \,\mathrm{cm^{-3}}$, $12 \times 12 \,\mathrm{mm^2} \times 525 \,\mu\mathrm{m}$) surface until the intended number of layers was reached. On the corner of the graphene, an Al contact ($2 \times 2 \,\mathrm{mm^2}$, 3000 Å) to collect electrons was formed by e-beam evaporation through a shadow mask. Figure 2(b) shows the time evolution of the open circuit voltage (V_{oc}) of the devices with 1 and 2 ML graphene as a photovoltaic response to a photon source ($100 \,\mathrm{mW \, cm^{-2}}$). Initial fluctuations of V_{oc} upon photon illumination rapidly disappeared, and it stabilized at values of $0.10 \,\mathrm{V}$ for 1 ML and $0.17 \,\mathrm{V}$ for 2 ML devices. This is a transient effect as the devices approach a thermal equilibrium.

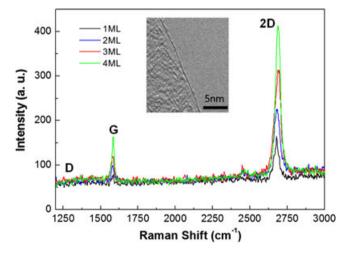


Figure 1. Raman spectra of graphene films transferred layer-by-layer onto a Si substrate. The 2D/G peak ratios do not change significantly as the number of layers increases from 1 to 4. The inset shows a transmission electron microscopy image of the monolayer graphene.

The current density *versus* the bias voltage of as prepared devices is plotted in Fig. 2(c) for 100 mW (AM 1.5 G) illumination. The $V_{\rm oc}$ of devices with 1, 2, 3, 4 graphene layers are -110, -190, -50 and -3 mV, respectively. Power conversion efficiencies (η) for devices with 1 and 2 ML graphene are about 0.01% with a fill factor of about 0.23 for both with a short-current density ($J_{\rm sc}$) of 0.33 and 0.19 mA cm⁻², respectively. However, the devices with 3 and 4 MLs had η below 0.001%.

The $V_{\rm oc}$ is exclusively dependent on the work function difference between FLG and Si substrate as in the case of the metal/ semiconductor (MS) structure. Because the work functions of the Si substrates in all devices are almost the same, V_{oc} is determined by the work function values of the FLGs. Except for the 2 ML sample in Fig. 2(c), V_{oc} decreases as the number of graphene layers is increased. This is opposite to the result observed in Raman spectra, showing no significant difference between one and multilayer graphene. This implies that a weak interlayer interaction via π orbitals is established despite random stacking of graphene layers. To remove unexpected effects induced by contaminants adsorbed on the FLGs during chemical preparation processes, the samples were annealed at 500 °C for 12 h in the vacuum chamber (base pressure: 4×10^{-10} Torr) directly connected to the photoemission spectroscopy chamber. The J-V curves of the devices after annealing are shown in Fig. 2(d). V_{oc} decreased in sequence, -120, -50, -30 and -5 mV, as the number of graphene layers increased. This indicates that the work function difference of FLG from Si is decreased as the number of graphene layers increases. In J-V measurement electrons are collected by the aluminum contact through the devices, implying that the work function of FLG has to be lower than that of the Si substrate and that the work function of FLG is increased as the number of graphene layers increases. This result is consistent with the recent result of Yu et al. They showed that the work function of the double layer graphene exfoliated from graphite was higher ($\Delta \phi = +0.12 \, \text{eV}$) than that of single layer graphene $(\phi = 4.57 \pm 0.05 \,\mathrm{eV})$ using scanning Kelvin probe microscopy and explained this as a result of chemical stabilization driven by interlayer interactions.^[13] Figure 3(a) shows the onset of the secondary cut-off (SC), E_{SC} , of photoemission electron spectrum from as-introduced samples at a bias of $-5\,\mathrm{V}$ using an ultraviolet source (He I: hv = 21.2 eV). The variation of SC value is directly dependent on the change of work function, as $\Delta \phi = \Delta \{hv - (E_f - E_{SC})\} = \Delta E_{SC}$. Here, E_f is the Fermi level of a sample. The inset of Fig. 3(a) shows the work function difference, $\Delta \phi_G (= \phi_G - \phi_{si})$, between as-introduced FLG and the Si substrate (ϕ_{si} = 4.61 \pm 0.02 eV). The work function of Si substrate beneath the FLG was estimated from the SC (gray line in Fig. 3(a)) of the exposed Si surface by Ar+ion sputtering until the signals of foreign atoms disappeared from the X-ray photoemission electron spectrum. The work function variation was similar with that of $V_{\rm oc}$ in Fig. 2(c), as the numbers of layers changed. Unexpectedly, 2 ML graphene had a lower work function and higher V_{oc} than the others. Figure 3(b) shows the SC of FLG after annealing at 500 °C for 12 h in the vacuum chamber. Interestingly, the SC value is well behaved, i.e. it increased as the number of graphene layers increased without any exception. This implies a sequential decrease of contact potential energy, $\Delta\phi_G$, which agrees well with the behavior of $V_{
m oc}$ in Fig. 2(d). Note that the work function difference (0.04 eV) between 1 and 2 ML graphene is smaller than that (0.12 eV) of exfoliated ones.[13] This shows weak interlayer interactions of FLGs prepared by layer-by-layer transfer because of random



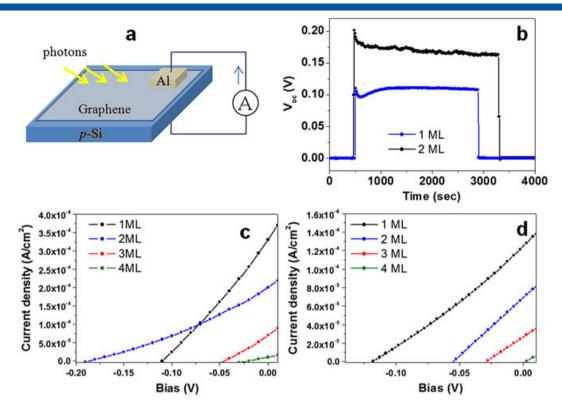


Figure 2. Photovoltaic responses of graphene/Si. (a) A schematic view of the sample; (b) plot of open-circuit voltage *versus* time of 1 and 2 ML graphene/Si; (c) plot of *J–V* of as-introduced samples with 1 ~ 4 ML graphene on Si, and (d) after annealing at 500 °C for 12 h.

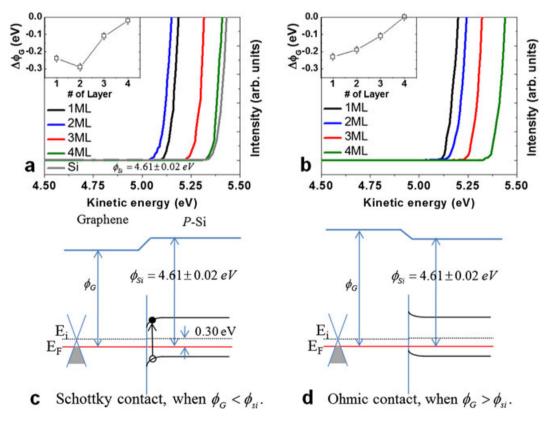


Figure 3. Work function modulation of FLG and electronic structure at the interface of FLG and Si. (a) Onset of SC of UPS spectra of as introduced FLG (1 ~ 4 ML graphene) and the pristine Si surface. The work function difference between FLG and the pristine Si surface is shown in the inset. (b) Onset of SC of the FLG after annealing at 500 °C for 12 h, with work function differences in the inset. (c) Electronic structure when Schottky contact is established. The electron-hole pairs photo-generated within the depletion region of Si are separated by the built-in potential. (d) Electronic structure, with Ohmic contact.

interlayer stacking. The prominent dependence of $V_{\rm oc}$ on $\Delta\phi_G$ indicates that the photovoltaic effects in the FLG/Si structure can be described by the photovoltaic effect of a MS structure. The MS cell's open-circuit voltage, $V_{OC} = n[\phi_B/q + (kT/q)] \ln r$ $(I_s/A_cA^+T^2)$], mainly depends on the contact barrier, $\phi_B = \phi_{Si} - \phi_{Si}$ $\phi_G = \Delta \phi_G$, and diode quality factor, n, because kT at room temperature (~ 0.0259 eV) is far smaller than ϕ_B . A_c and A^+ are the contact area of the diode and the Richardson constant, respectively.^[20,21] The schematic view of the electronic structure of FLG/Si structure is shown in Fig. 3(c) when $\phi_{\rm G}$ < $\phi_{\rm Si}$ and Fig. 3 (d) when $\phi_G > \phi_{Si}$. If the work function of FLG is smaller than that of Si substrate, Schottky contact is established with transition region spread into the Si substrate, where charge separation of the electron-hole pairs created by photons occurs. As the work function of the FLG increases with the number of graphene layer, the contact potential $\Delta\phi_G$ and the rectifying character responsible for the photovoltaic effect is decreased. This well explains why a negligible photovoltaic effect occurs in the samples with 3 and 4 ML graphene. The opposite case of Schottky contact is Ohmic contact when the work function of FLG exceeds that of Si as shown in Fig. 3(d). In this case the majority carrier current passes easily in either direction because of low contact resistance.

In all devices $V_{\rm oc}$ is about 100 mV smaller than that of the estimated Schottky barrier, $\Delta\phi_{\rm G}$. If the FLG is approximated as a metal, the depletion width in the transition region of Si is about 0.56 µm from the equation $W \approx \sqrt{2\varepsilon\Delta\phi_{\rm G}/qN_{\rm a}}$, where $N_{\rm a}$ is the density of boron. This indicates that the largest portion of the Si substrate acts as a series resistor in the devices. This explains the lower $V_{\rm oc}$ than expected value.

The modification of FLG after annealing was characterized in the connected analysis chamber using photoemission electron spectroscopy. Figure 4 shows the C 1s spectra at hv = 350 eV from synchrotron radiation source. The parameters of decomposed peaks are characterized by two divided parts: The parameters of the peaks originating from FLG include a Doniac-Sunjic line shape, using a Lorentzian line width of 178 meV and an asymmetry factor of 0.07 following the previous result, [22] while the parameters of peaks of contaminant carbon species with asymmetric character were excluded because of weak coupling of contaminants with the graphene layer (see Table 1, for details of parameters). The C 1s spectrum of as-introduced 1 ML graphene was decomposed into one graphene peak and four peaks related with contaminants, which are integrated as the red area in the bottom spectra in Fig. 4. The considerable amount of uncontrollable contaminants explains the unexpected behavior appearing in the work function of as-introduced FLGs as a function of layers. However, the unexpectedly low work function of as-introduced 2 ML graphene, leading to high $V_{\rm oc}$, shows another possible challenge to increase V_{oc} by controlled doping of the graphene. Upon annealing the sample the C 1s spectra are well characterized by two peaks originating from FLG and another two peaks from contaminants. In the case of 1 ML graphene only one graphene related peak shown by the blue area, named M, appears with two contaminant peaks named C1 and C2. In the 2 ML graphene, the monolayer peak, M, is decreased while a bulk graphene peak represented by black area is visible at 284.45 eV. In the 4 ML graphene, the monolayer peak is completely replaced by the bulk graphene peak B. This result is comparable to that of an exfoliated graphene sample whose work function depends on the number of layers. [13,23] The contaminant related peaks, C1 and C2, are gradually decreased and only a negligible amount is

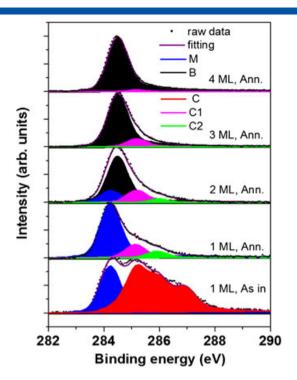


Figure 4. C 1s core level spectra taken at hv = 350 eV. Peaks in blue and black area, named M and B, are the main features of monolayer graphene and bulk graphene, respectively. Both have a Doniac–Sunjic line shape. The C 1s spectrum of as-introduced 1 ML graphene, the bottom one, has one monolayer peak and four contaminant related peaks, which are integrated as the red area. C 1s spectra of $1 \sim 4$ ML graphene after annealing at $500 \,^{\circ}$ C are shown in the second to top figure. Two contaminant related peaks, shown by pink and green areas, decreased as the number of layers increased, while the monolayer peak, M, is replaced by the bulk peak, B, at 4 ML graphene.

Table 1. Best-fit results and estimated contribution to Doniac–Sunjun line shape, which is the characteristic feature of graphene. Gaussian widths (GW) of all peaks are fixed at 752 meV, Lorentzian width (LW) and asymmetry (ASY) are set to 178 meV and 0.07 for two graphene related peaks.

	# of layer	$E_{\rm B}$ (eV)	Area	LW (meV)	GW (meV)	ASY.
As in	1 ML	284.20	0.86	178	752	0.07
		284.46	0.12	178	752	0.07
		285.15	0.78	0	752	0.00
		285.94	0.52	0	752	0.00
		286.89	0.37	0	0	0.00
Annealed	1 ML	284.20	1.00	178	752	0.07
		285.15	0.24	0	752	0.00
		285.94	0.12	0	752	0.00
	2 ML	284.20	0.21	178	752	0.07
		284.46	0.84	178	752	0.07
		285.15	0.22	0	752	0.00
		285.94	0.06	0	752	0.00
	3 ML	284.20	0.00	178	752	0.07
		284.46	0.96	178	752	0.07
		285.15	0.15	0	752	0.00
		285.94	0.01	0	752	0.00
	4 ML	284.20	0.00	178	752	0.07
		284.46	1.00	178	752	0.07
		285.15	0.03	0	752	0.00
		285.94	0.01	0	752	0.00



visible in 4 ML graphene. This indicates that the C1 and C2 contaminants are localized between the Si and FLG, where they are difficult to desorb by an annealing process.

Conclusion

In summary, we have shown the modulation of the work function of FLG by controlling the number of graphene layers grown by CVD method. The photovoltaic response is found to directly depend on the number of graphene layers in the FLG/Si structure, similarly to the surface photovoltaic effects of a low coverage metal–semiconductor junction. The surface photovoltaic effect found here is a possible model system to estimate the modified electronic structure at the interface of a graphene heterojunction, which is commonly encountered in graphene research.

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